



New Irradiation facility at CERN: CHARM



CERN R2E project

Electronics Coordination Board 11th October 2013

J. Mekki, M. Brugger
for the CERN R2E Project
www.cern.ch/r2e

**!!! Many Thanks To All Project Members
and for the fruitful collaboration with the PH department !!!**

@ Introduction

@ Why do we do radiation tests ?

@ Radiation field

@ Particle spectra and energy dependence

@ New facility

@ Conclusion

CHARM

Cern High Energy

Accelerator Mixed Field/Facility

@ We'd also Other Good Options,

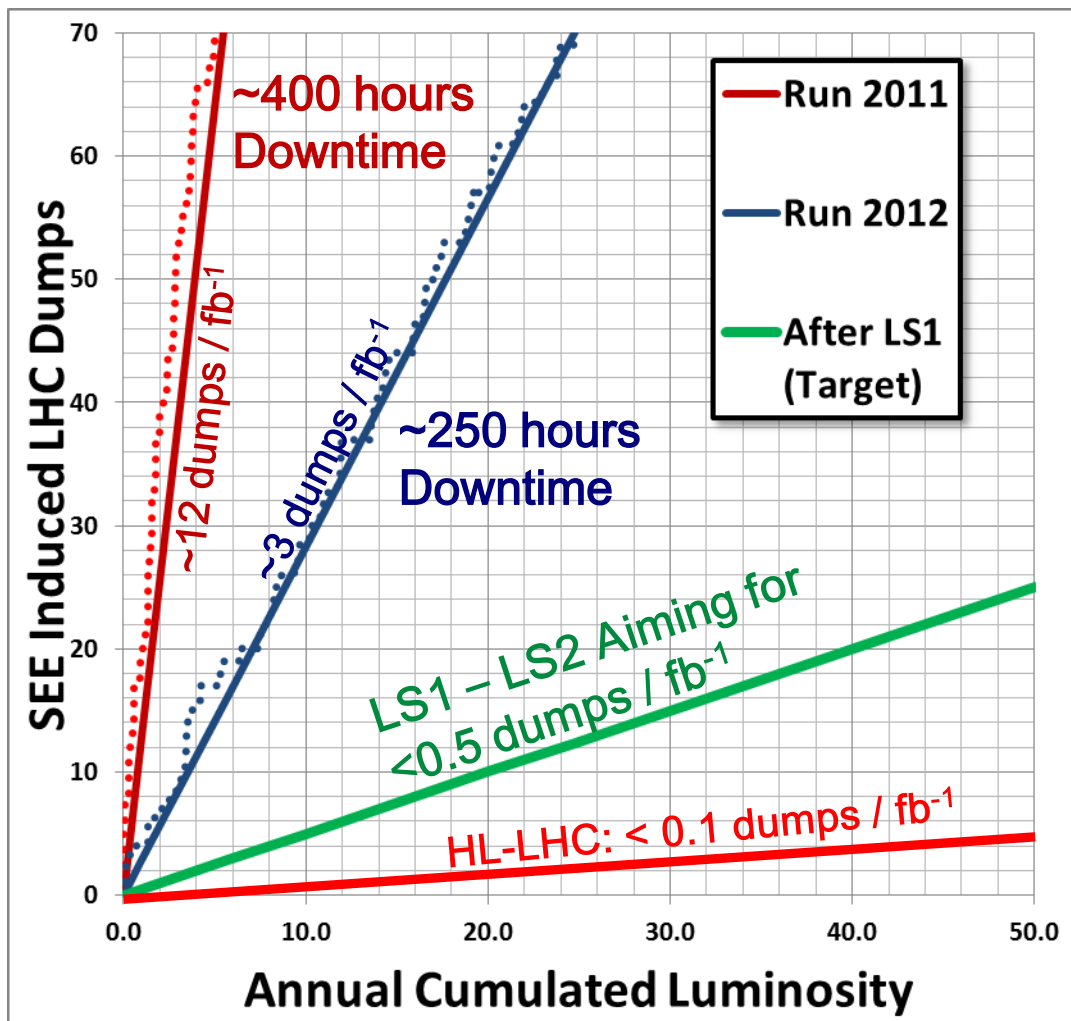
... But

@ CHER (French = expensive)

(Cern High Energy Radiation Facility



R2E SEE Failure Analysis



2008-2011

- Analyze and mitigate all safety relevant cases and limit global impact

2011-2012

- Focus on long downtimes and shielding

LS1 (2013/2014)

- Final relocation and shielding

LS1-LS2 (2015-2018)

- Tunnel equipment and power converters

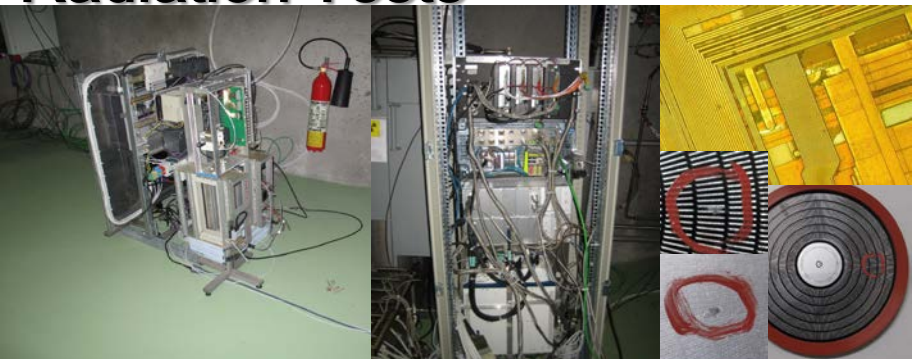
- TE/EPC (e.g Power converters) -> *Development up to 2018*
- EN/EL (e.g UPS) -> *Development up to 2016*
- QPS
- LHC experiments
- Cryogenics
- Beam Position Monitor
- EN/STI (e.g. component tests, RadMON V6)
- Beam Loss Monitors
- EN/ICE
- From Outside (Universities, laboratories, industrials: *e. g. radiation tests with particle spectra representative of atmospheric/ground environments*)
- And others



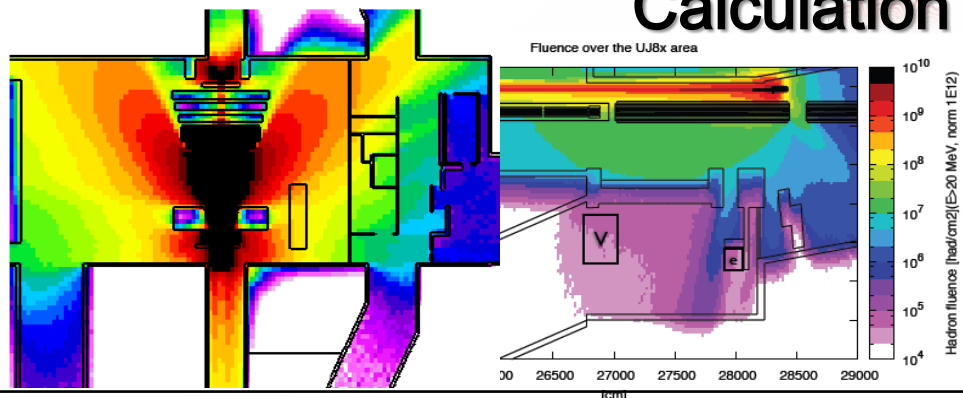
R2E Mitigation Project Building Blocks



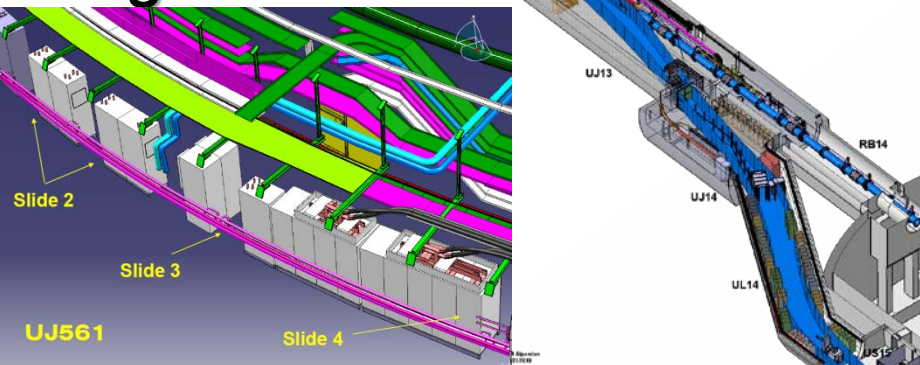
Radiation Tests



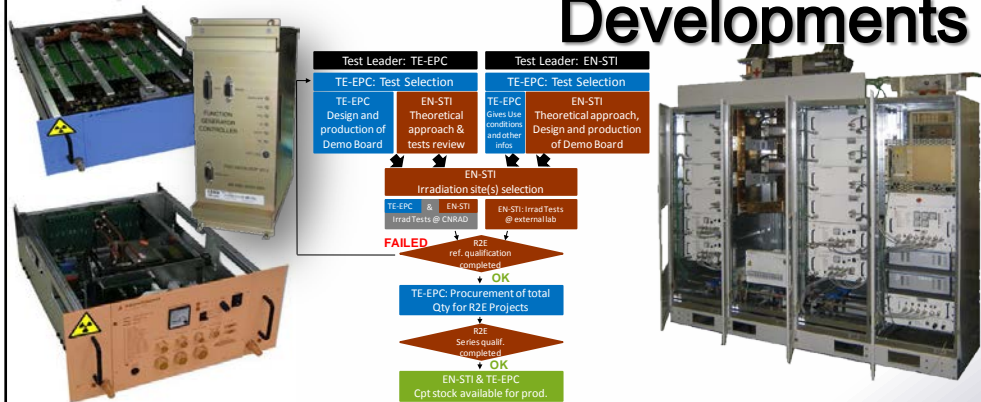
Calculation



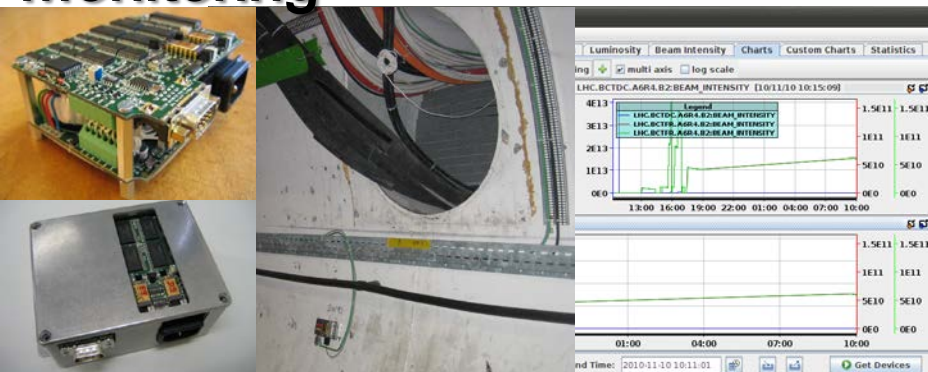
Integration



Developments



Monitoring

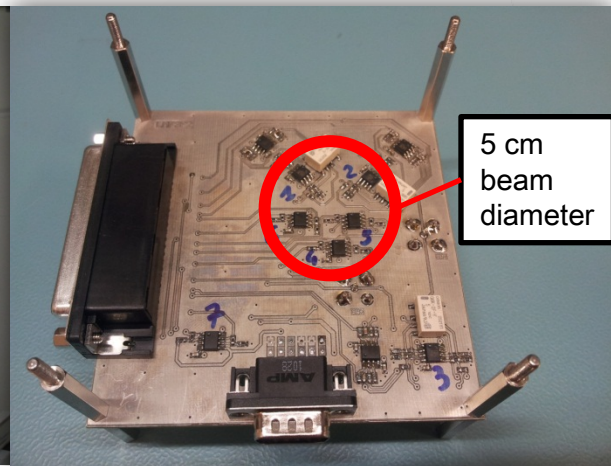
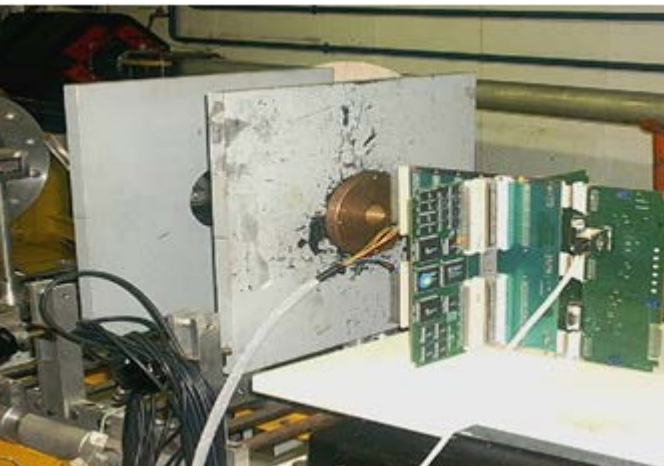


Implementation



Size Matters?

TEST COMPONENTS/CARDS:



OR EVEN TEST THIS:



HERE
➔



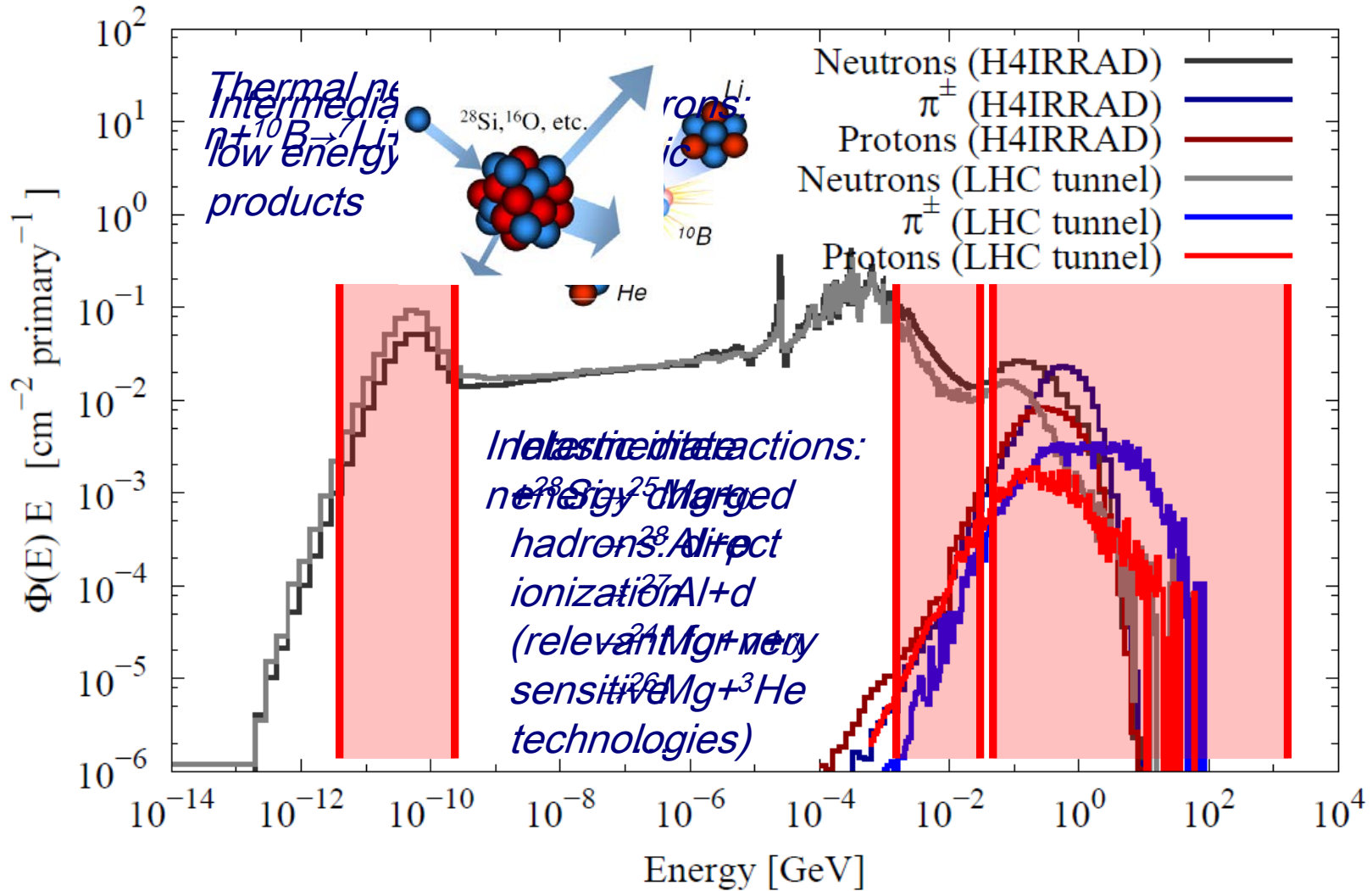
(W)HOW ???

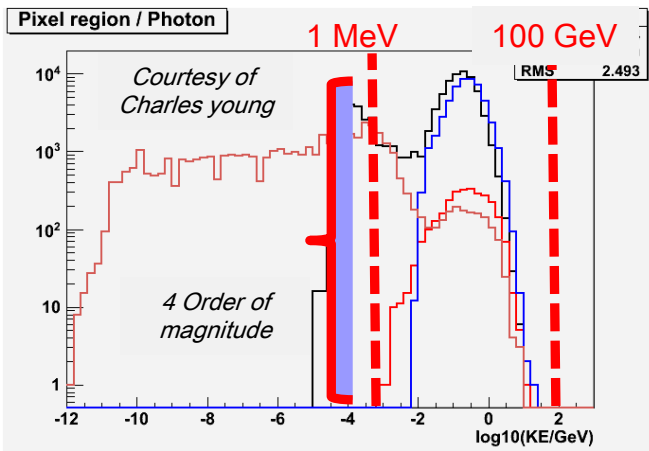


- ⊗ Radiation fields originated by **very high energy particles** interacting with different elements (collimators, gas, targets, etc.)
- ⊗ **Wide range of intensities!**

Ground level	Avionic	ISS Orbit	LHC machine	LHC Detectors	
1-2.10 ⁵	≈ 2.10 ⁷	≈ 1.10 ⁹	10 ⁶ - 10 ¹¹	> 10 ¹¹	<i>HEH/cm²/yr</i>

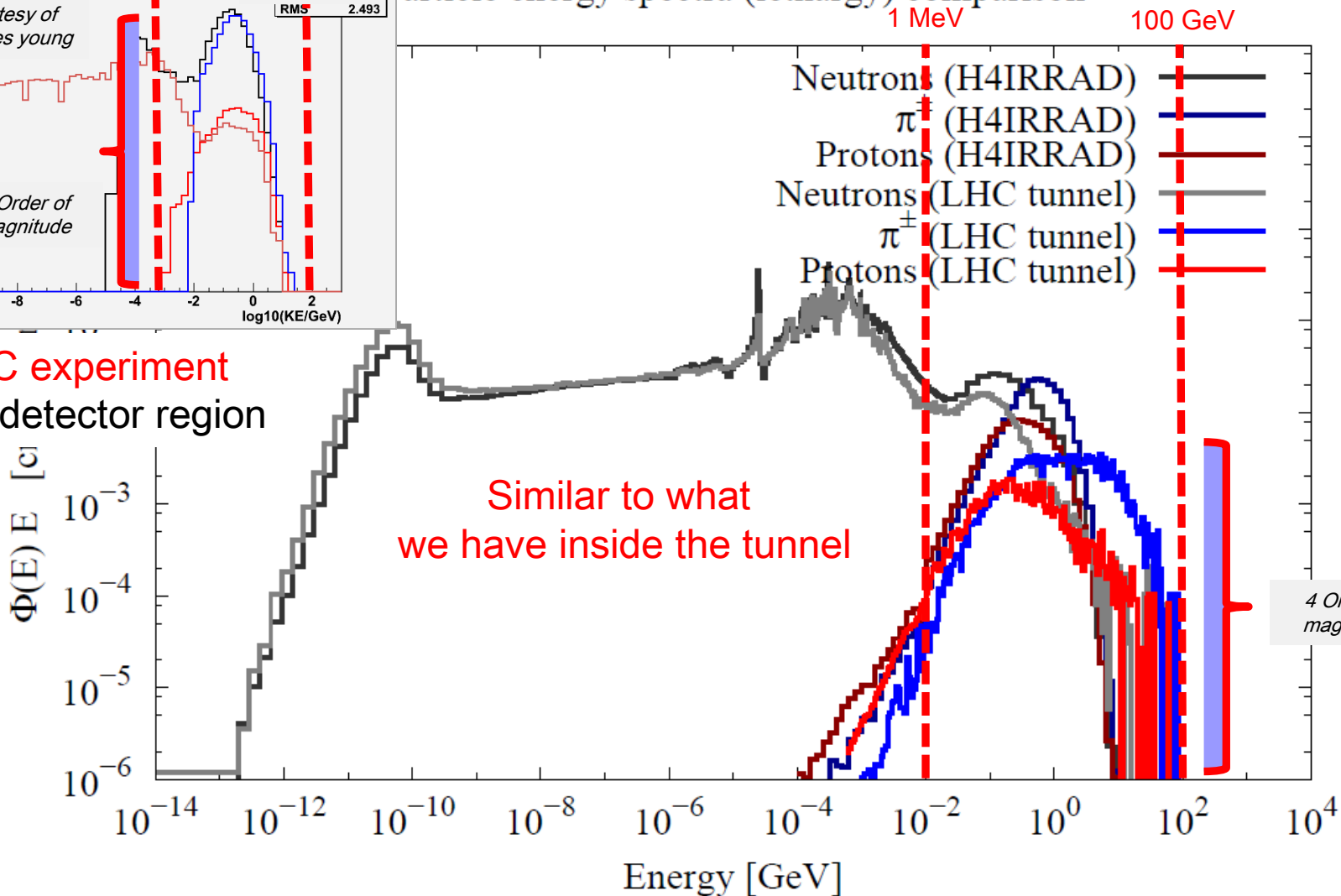
Particle energy spectra (lethargy) comparison

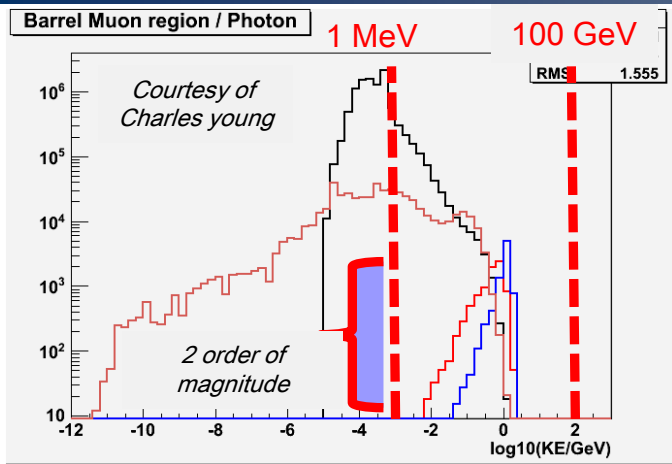




Particle energy spectra (lethargy) comparison

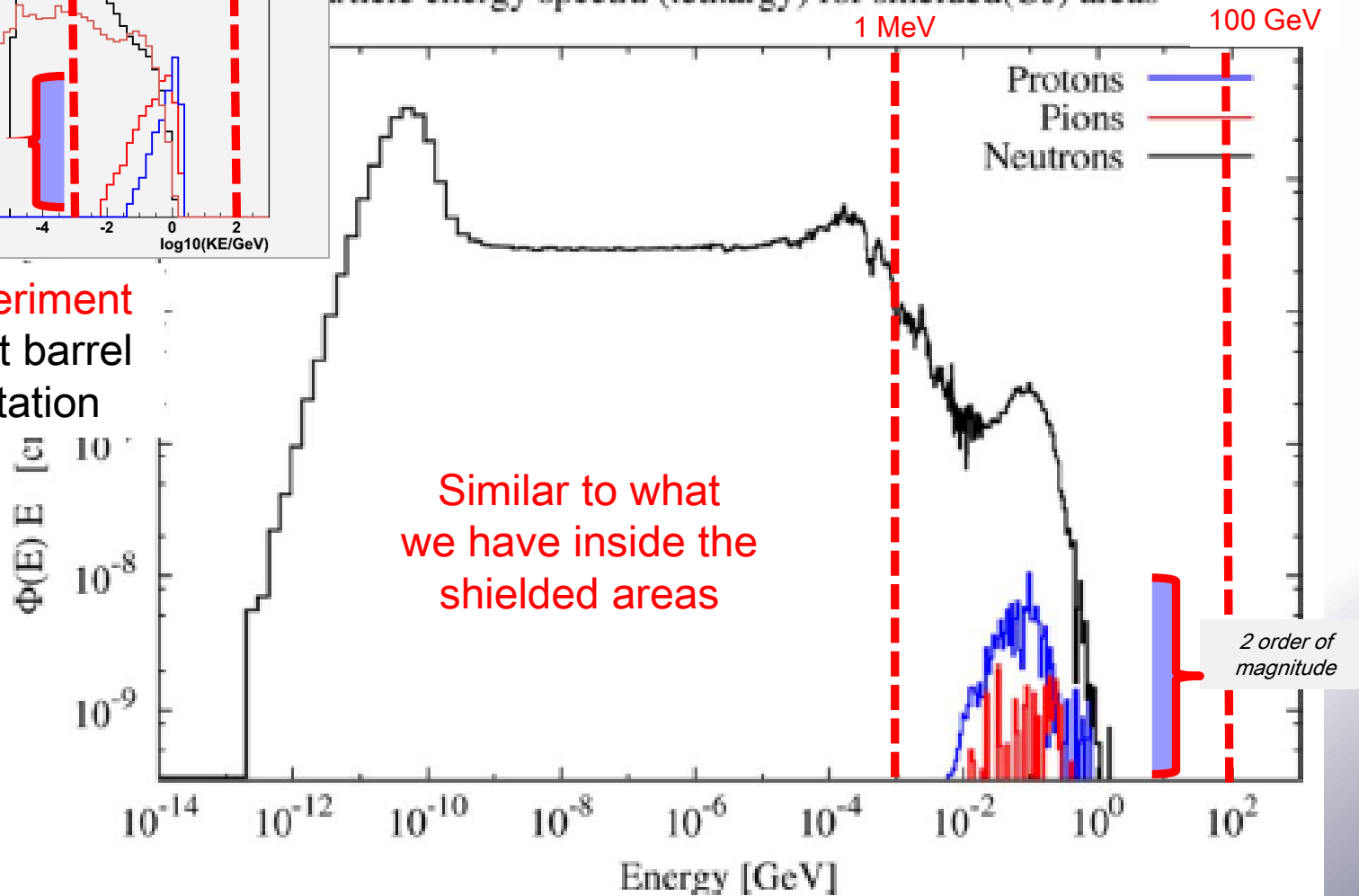
LHC experiment
Pixel detector region





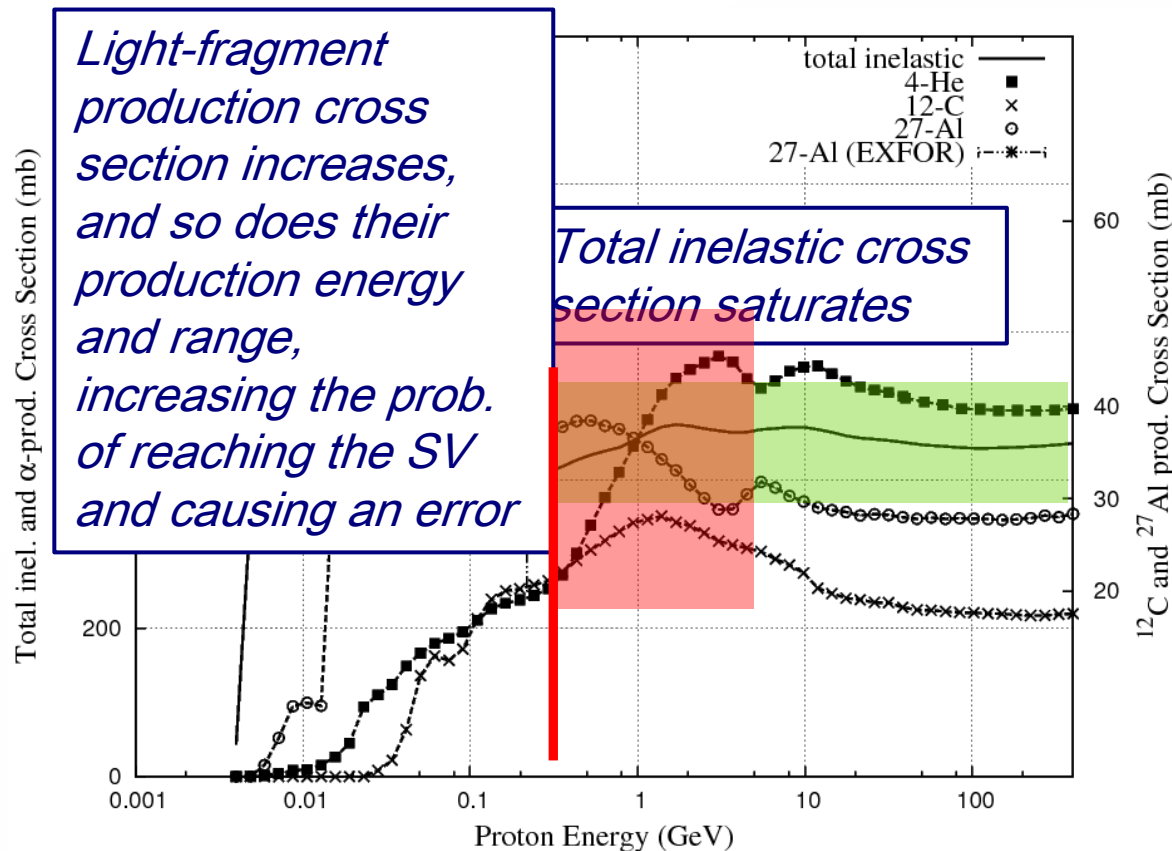
Particle energy spectra (lethargy) for shielded(UJ) areas

LHC experiment
Outermost barrel
muon station



Above ~100 MeV, the total hadron-Silicon inelastic cross section is saturated, however:

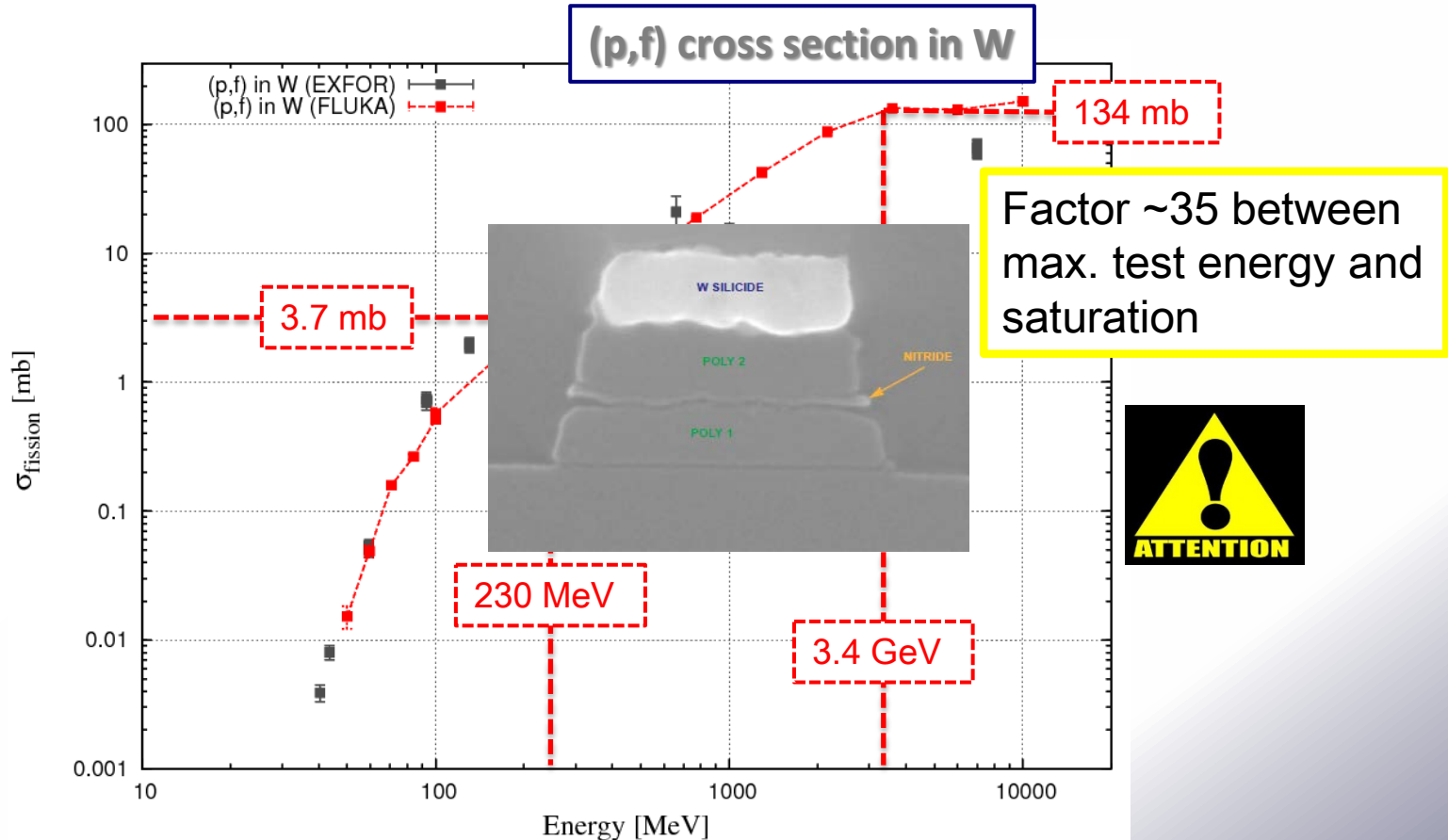
- more light, long-ranged fragments are produced
- and they are produced with larger energies (and therefore ranges)



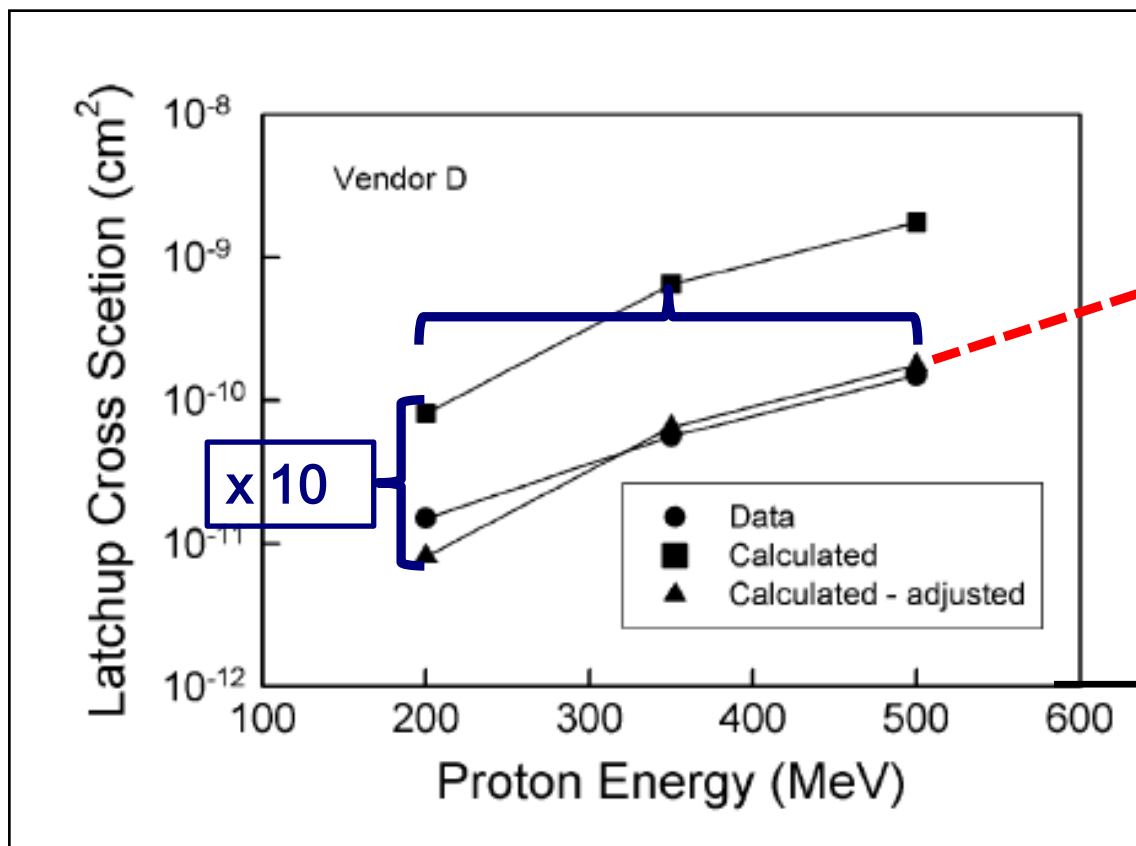
Fission: Energy Dependence



- ⊙ **High-Z materials** (namely **tungsten**) are often used in the interconnection layers of the memories, **near the sensitive volumes**
- ⊙ Energetic hadrons can induce **fission** in these materials, producing very **high-LET fragments** that can **dominate the SEE cross section**



SEL: Energy Dependence



1 GeV

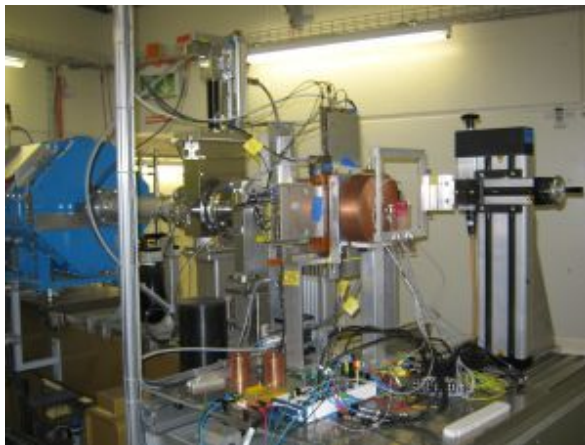
10 GeV



Schwank 2005 (IEEE TNS)

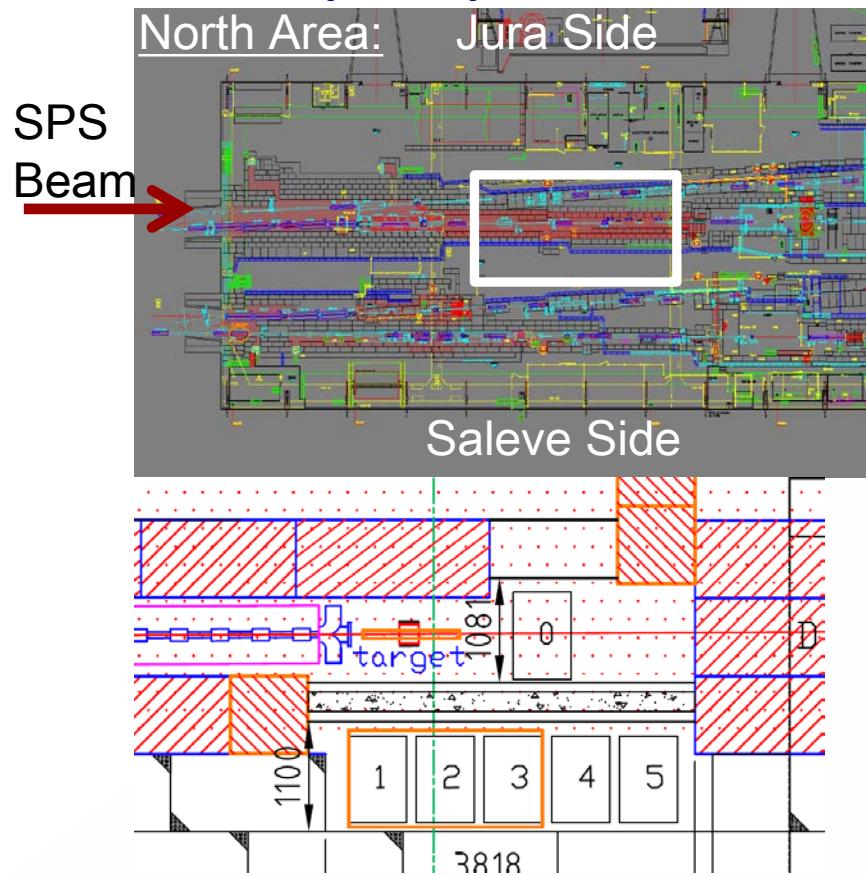
R. Garcia-Alia (CERN Thesis 2012-2014)

- ❑ Commercial components to be used in systems operating in radiation environments need to be **tested**.
- ❑ Standard **SEE test** are carried out at **PSI** (30-230 MeV protons) or at CERN **in-house test facilities** (mixed-radiation field).
- ❑ Testing is **expensive** and **time-consuming**, however the **criticality** of many of the potential failures is high (especially in terms of **beam-time loss**).
- ❑ The **risk** is foreseen to increase in the upcoming years due to increasing sensitivity and LHC intensity/luminosity.

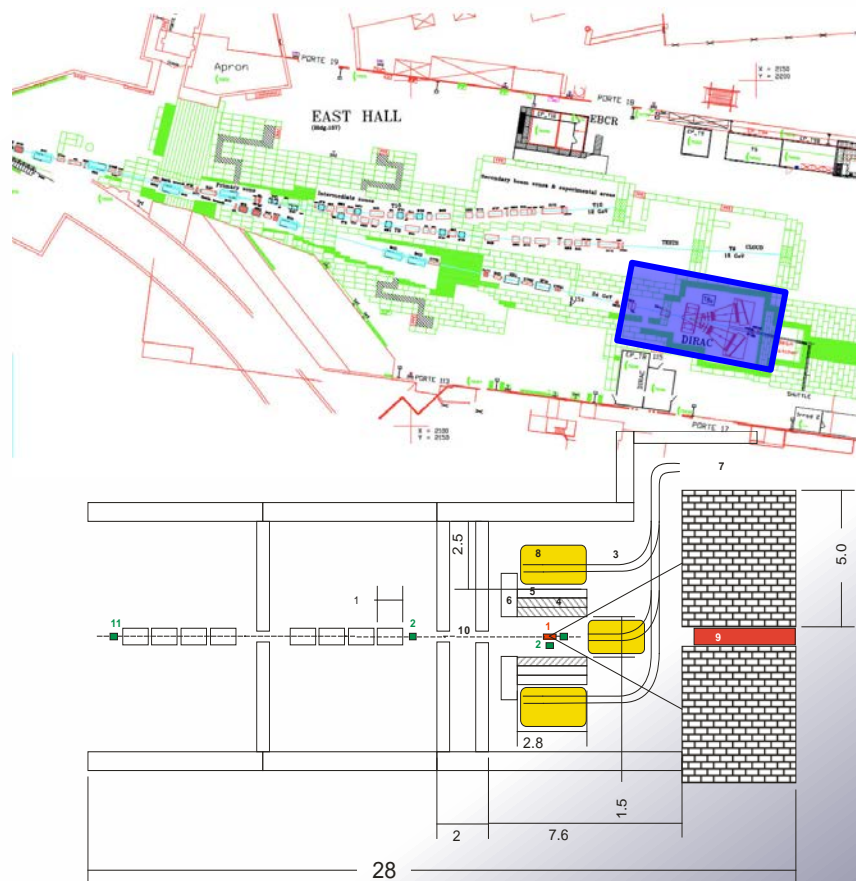


Extensive and **complex radiation test campaigns** exceed CERN's current test possibilities (ENRAD, H4irrad, PSI) – Important to think ahead!

@ H4IRRAD (2011)

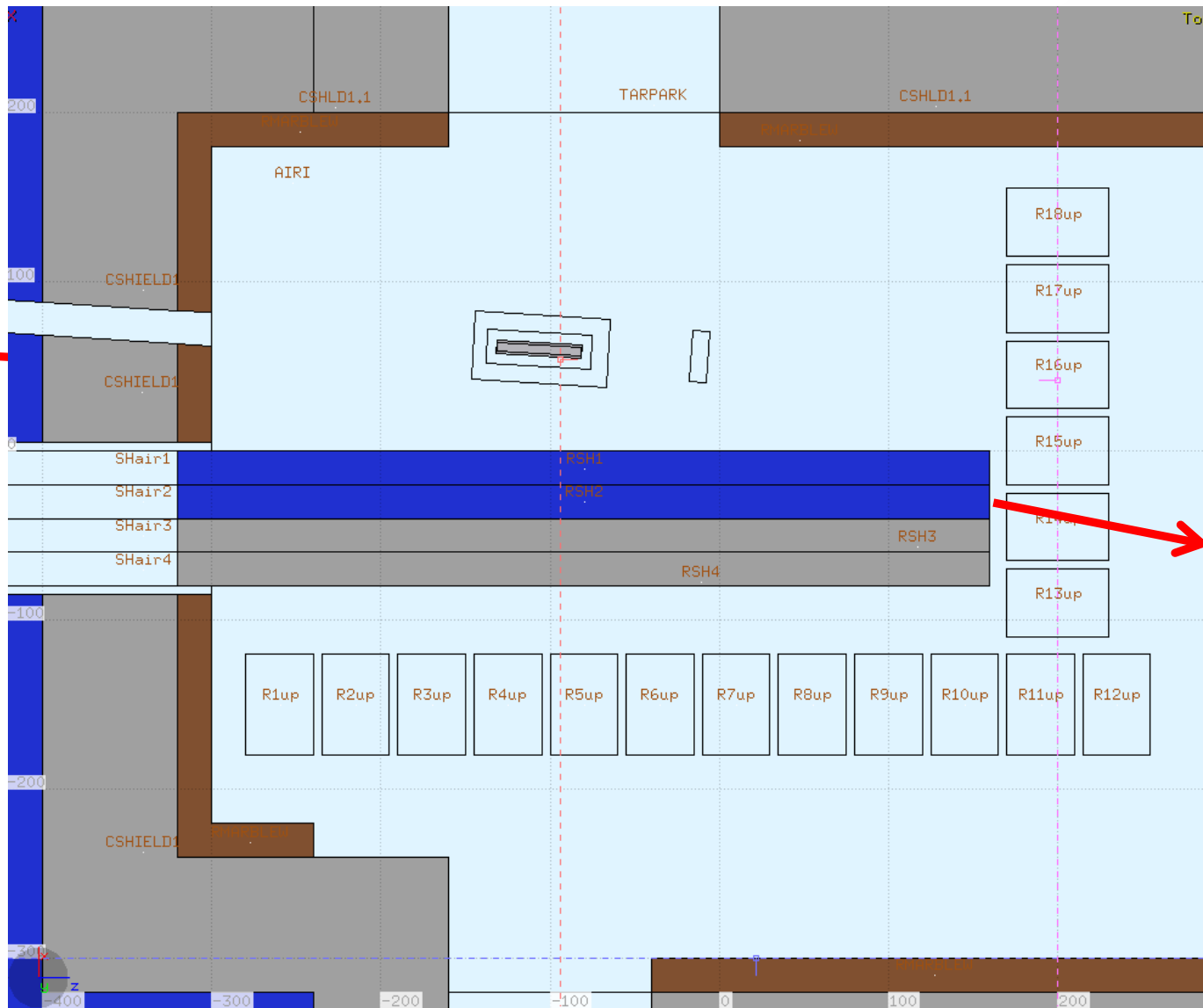


@ PS-EastArea (2014)



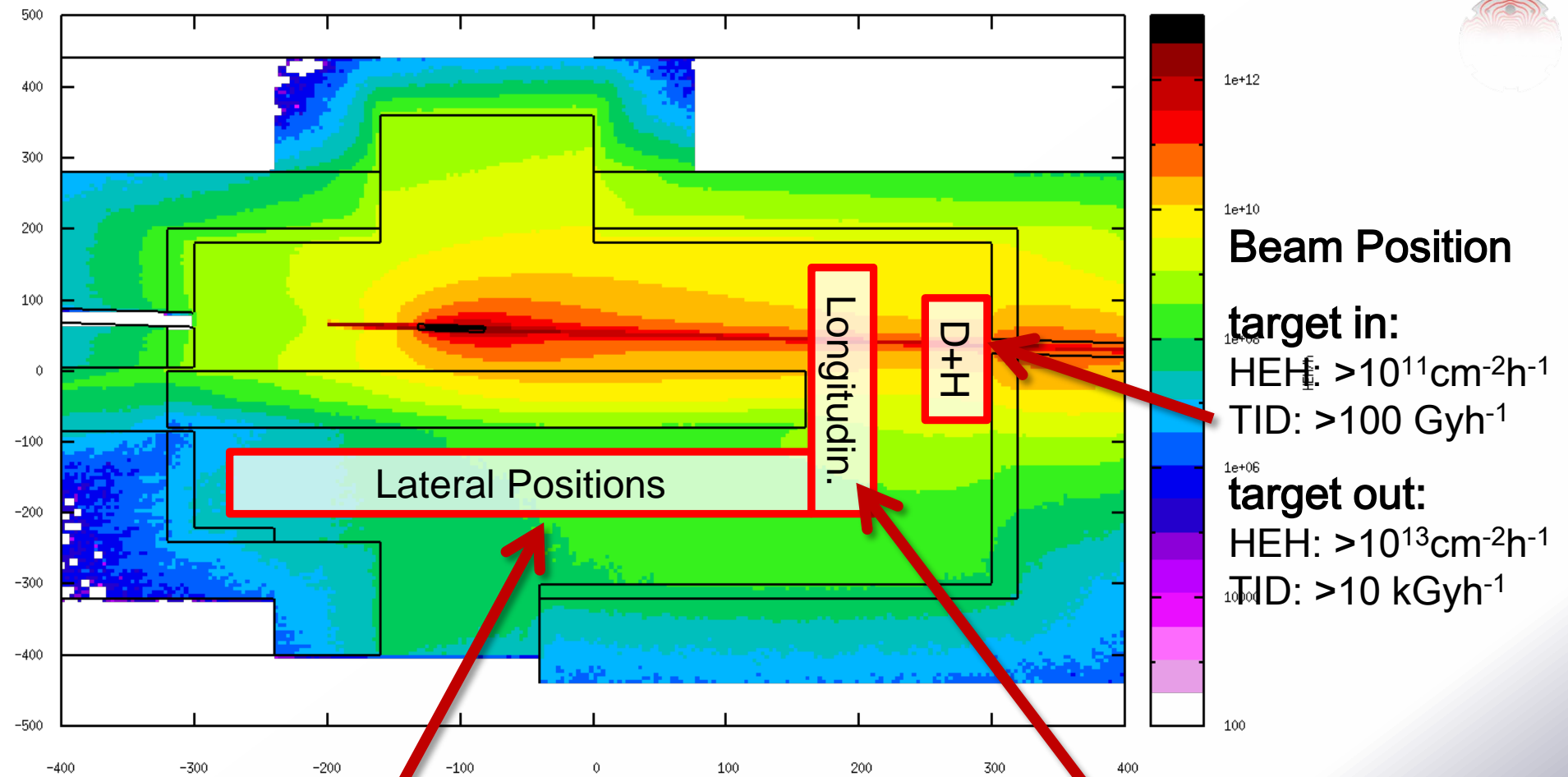


24 GeV/c
protons



4x40 cm
movable
shielding

HEH flux in HEH/h



Beam Position

target in:
 HEH: $>10^{11} \text{cm}^{-2}\text{h}^{-1}$
 TID: $>100 \text{Gyh}^{-1}$

target out:
 HEH: $>10^{13} \text{cm}^{-2}\text{h}^{-1}$
 TID: $>10 \text{kGyh}^{-1}$

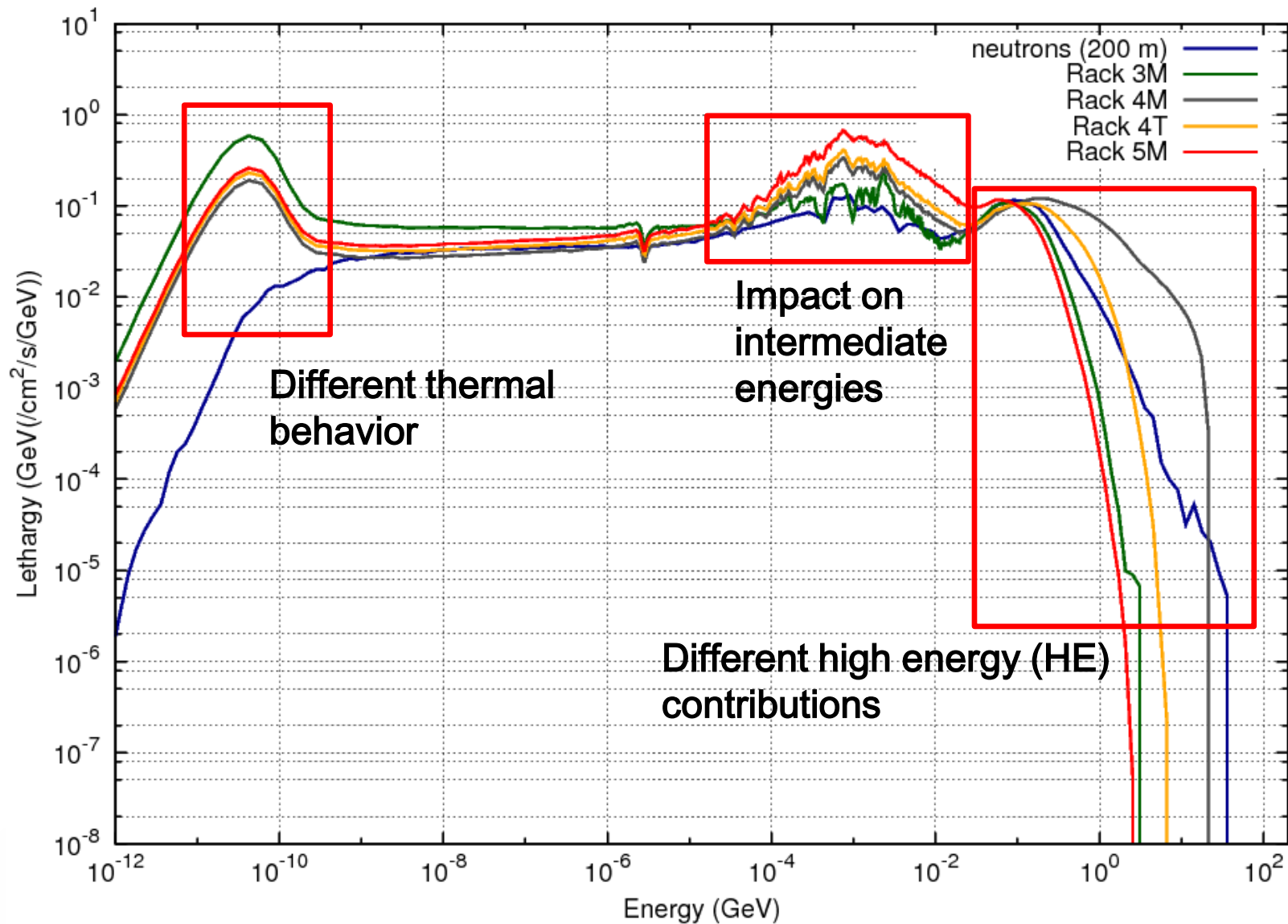
Full racks, crates, set of cards, components

HEH: $10^7 \text{cm}^{-2}\text{h}^{-1} - 10^{10} \text{cm}^{-2}\text{h}^{-1}$, TID: $10 \text{mGyh}^{-1} - 10 \text{Gyh}^{-1}$

HEH: $10^8 \text{cm}^{-2}\text{h}^{-1} - 10^{11} \text{cm}^{-2}\text{h}^{-1}$
 TID: $0.1 \text{Gyh}^{-1} - 100 \text{Gyh}^{-1}$
 (gradients to be considered)

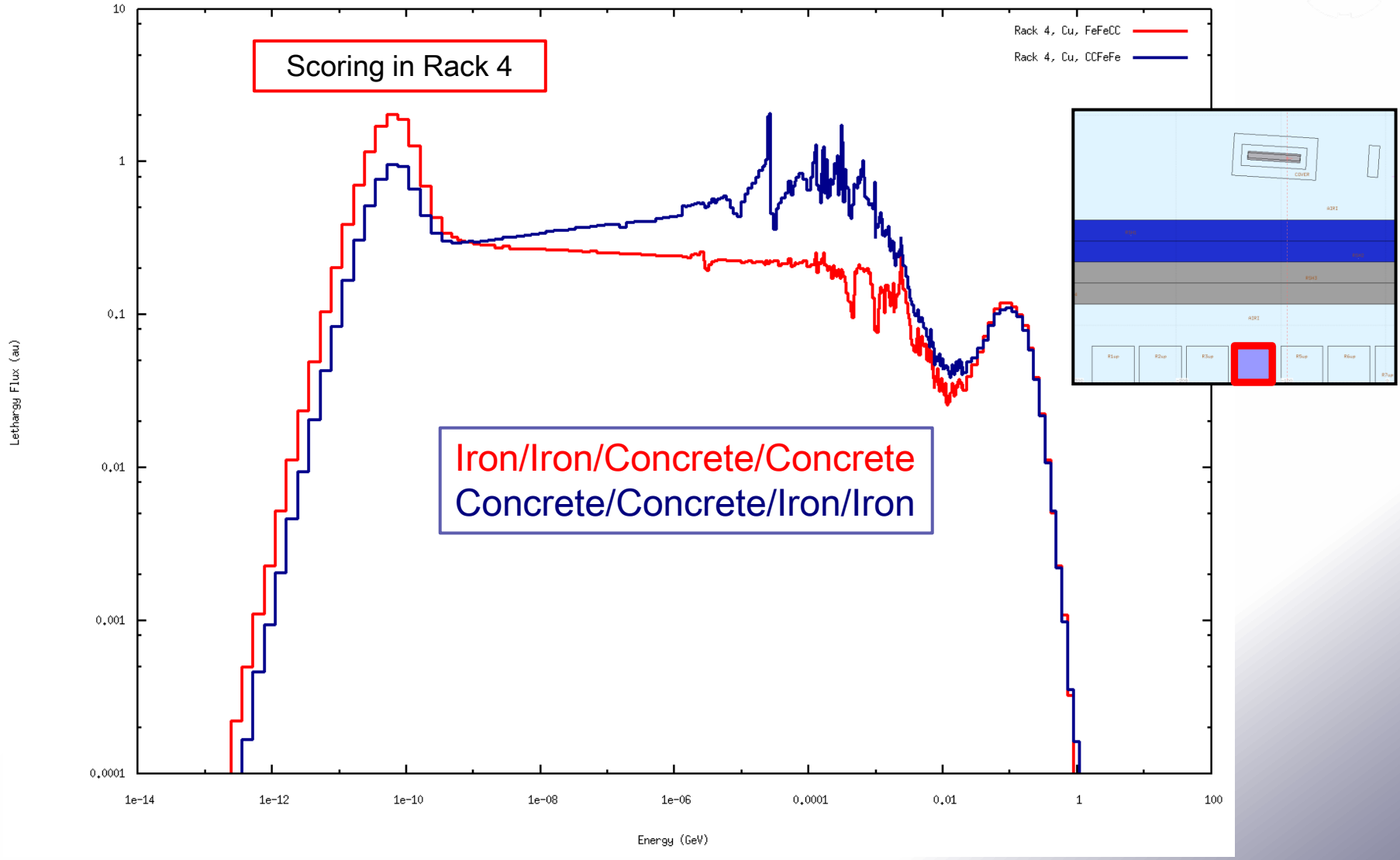
- Intensity reachable for 1 year (220 days) of beam operation in comparison to previous experimental test areas

	CNRAD	H4IRRAD	CHARM	
			Max	Min
HEH (cm ⁻²)	≈ 6×10 ¹²	≈ 3×10 ¹²	<u>Target Out:</u> >5.3×10¹⁶ <u>Target IN:</u> >5.3×10 ¹⁴	>5.3×10 ¹⁰
Dose (Gy)	≈ 880	≈ 315	<u>Target Out:</u> >53×10⁶ <u>Target IN:</u> >530×10 ³	>53

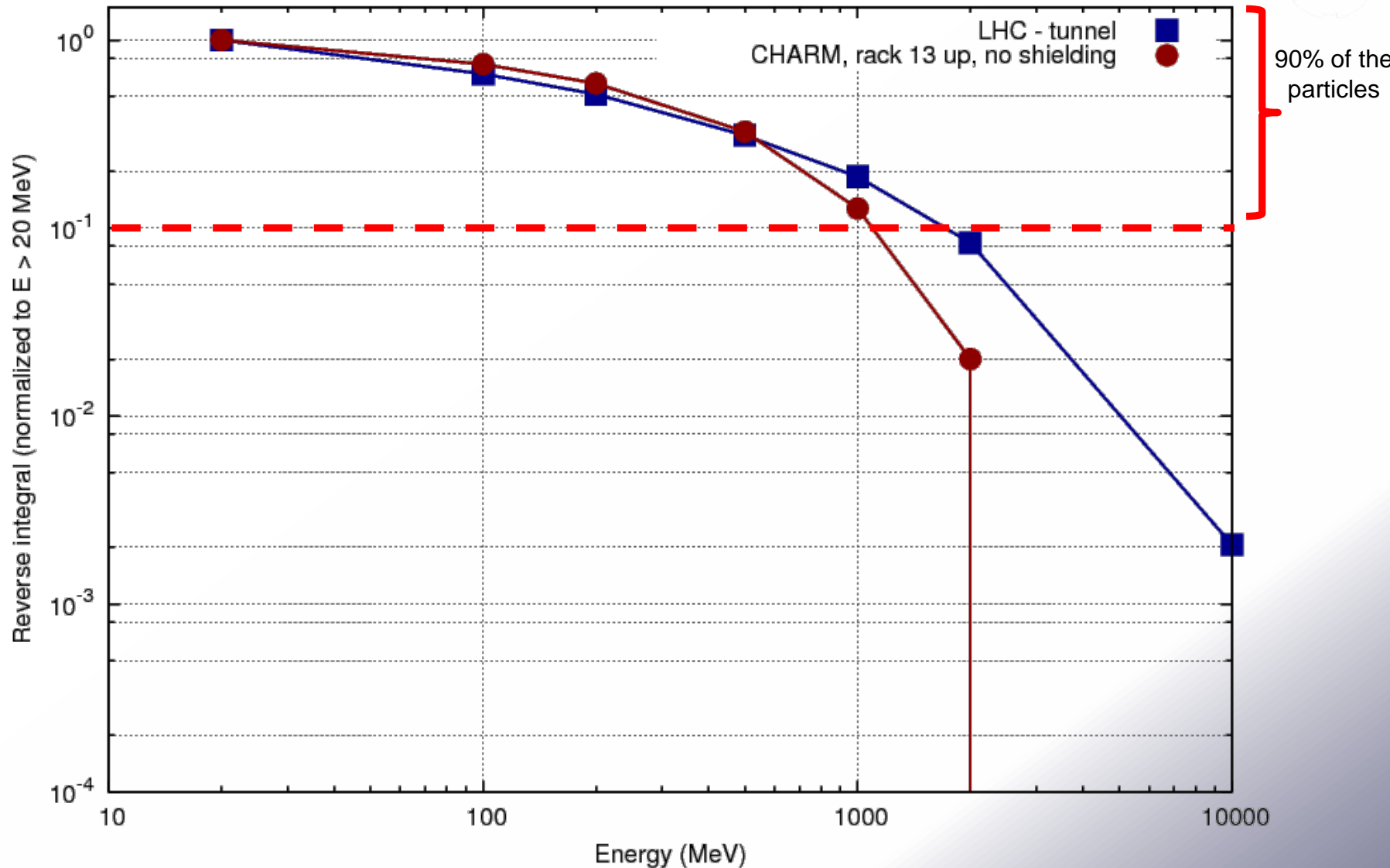




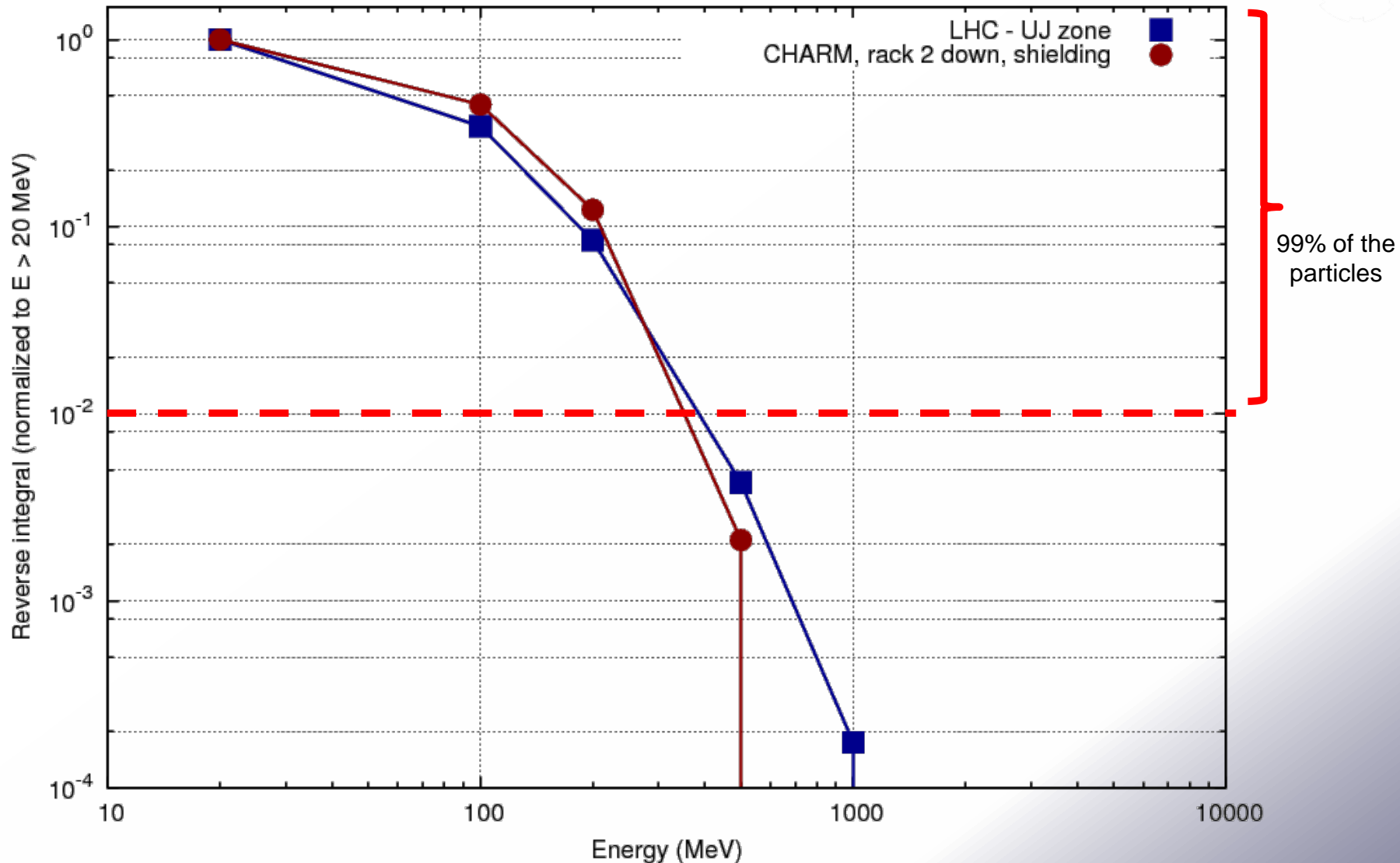
Rack 4 Neutrons, Shielding Effect



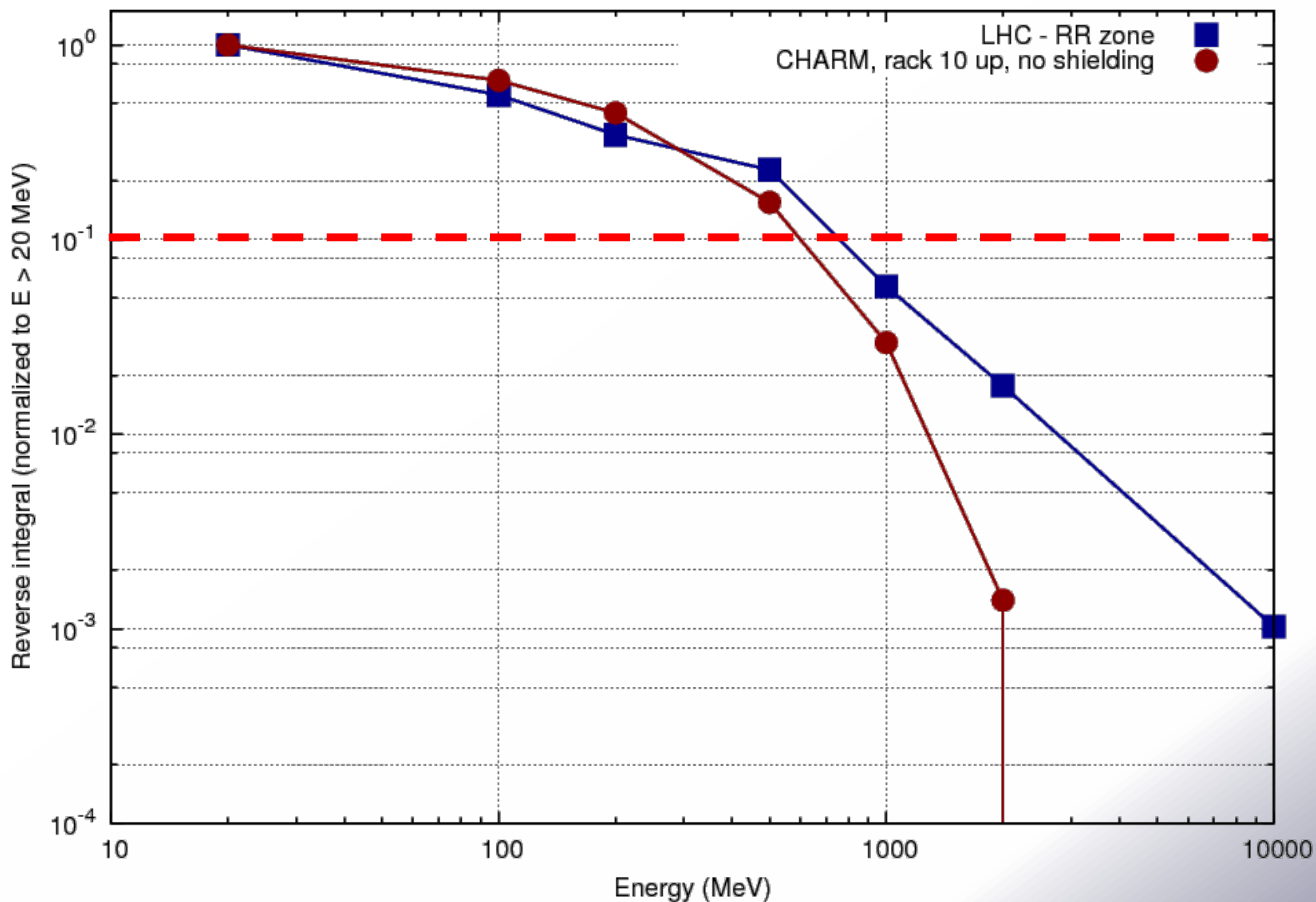
Accelerator Tunnels



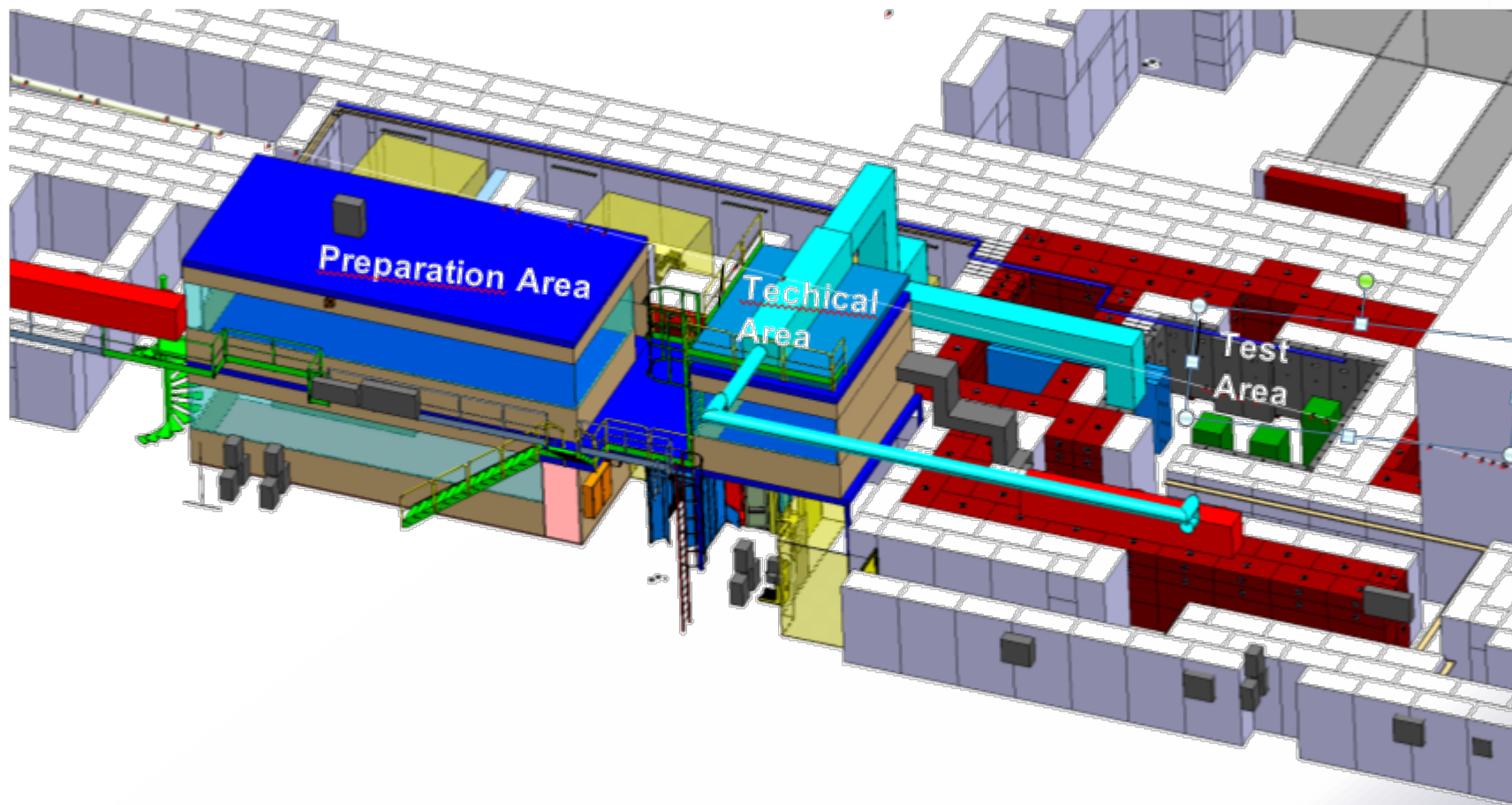
Accelerator Shielded Areas 1



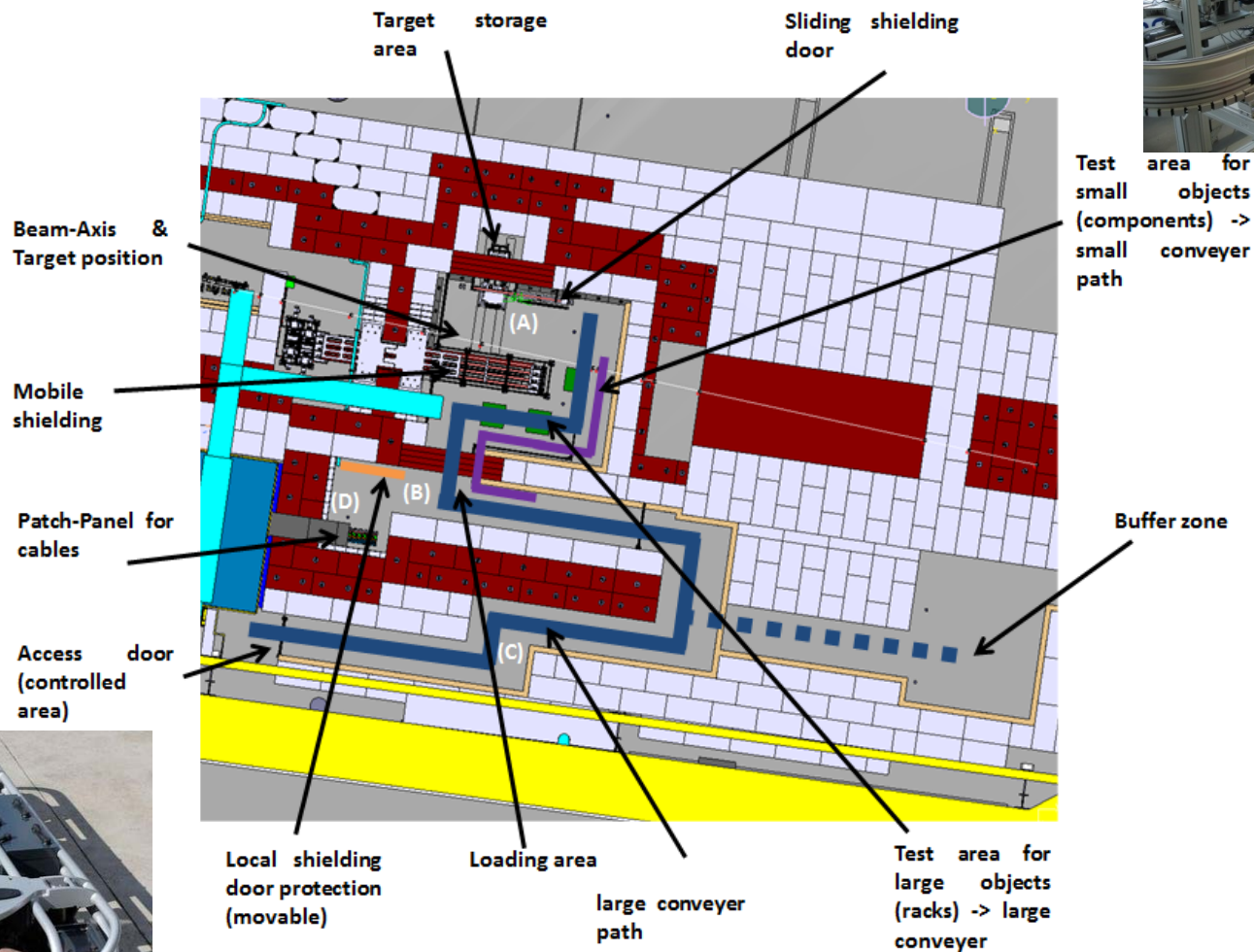
Accelerator Shielded Areas 2



Facility Overview



Main Elements



Test area for small objects (components) -> small conveyer path



Local shielding door protection (movable)

Loading area

large conveyer path

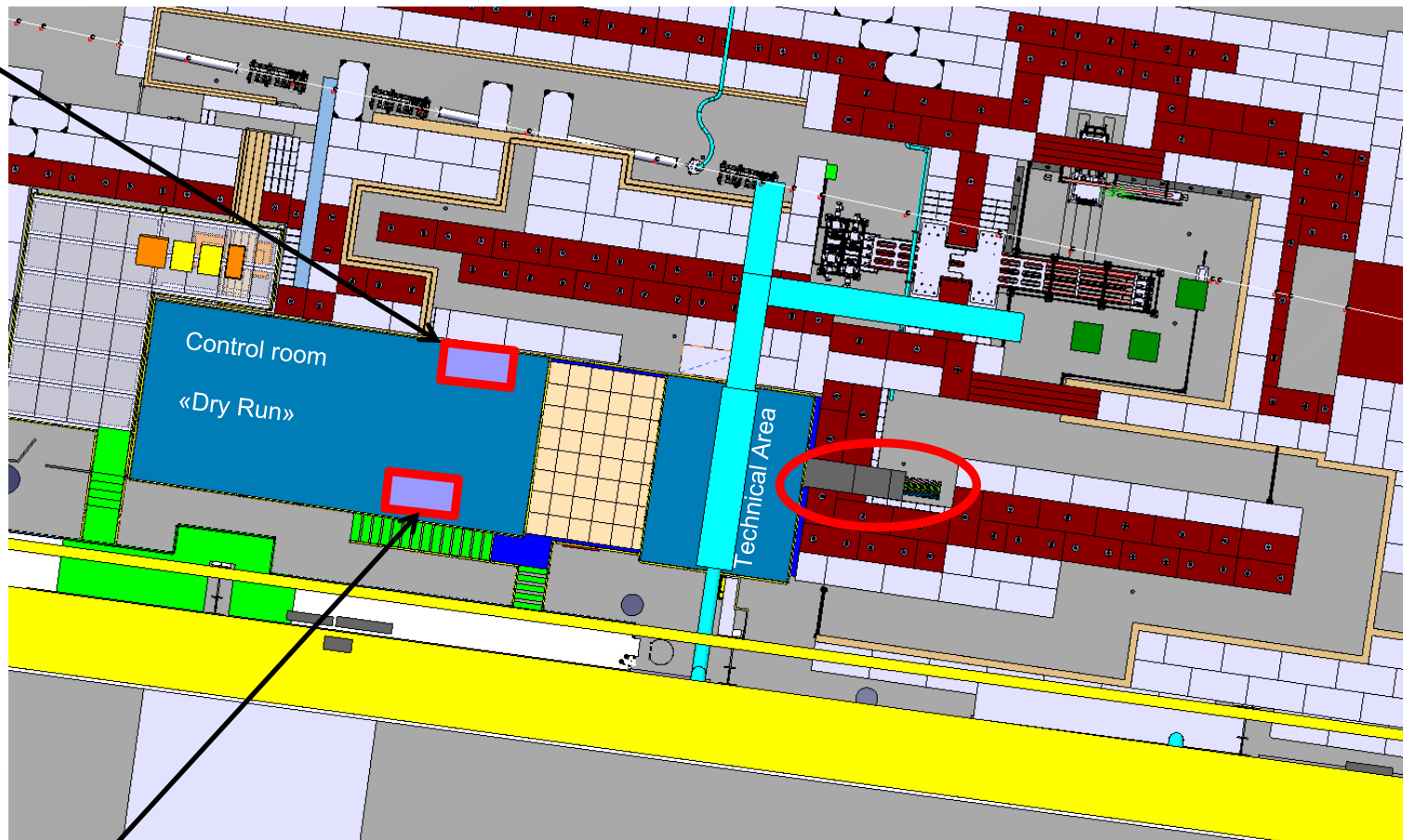
Test area for large objects (racks) -> large conveyer

Buffer zone

Cable Type	Code S.C.E.M	Connectors	Code S.C.E.M	Number of cables
NER48	No S.C.E.M	Burndy (female)	09.31.05.184.8 (connector) 09.21.05.430.0 (contact F)	6
Profibus	04.21.60.020.4	3 types	09.10.10.A	4
Single mode optical Fibres - Connector E2000				12
Single mode optical Fibres - FC/PC connectors				12
Multimode optical fibers -FC/PC connectors				24
Ethernet connections	04.21.70.105.9	RJ45	09.65.10.106.8 (connector) 09.65.10.121.0 (Cover) RS 453-2450 (panel socket)	12
CB50	04.61.11.225.6	BNC	09.46.11.700.4	50
WorldFIP	04.21.60.120.1	Connectors + boitier de raccordement	09.10.60.020.7 (Connector) 09.10.60.010.7 (FIP box)	3
Muti cond. Twisted/pair and shielded/pair	04.21.44.180.6	Prise rect. + contact femelle + Straight Metal Housing	09.21.07.075.9 (connector) 09.21.07.409.9 (contact F) 09.21.07.285.8 (socket 24B)	6
230V	04.08.61.733.6	Fiche Cable + Prise Cable + Prise Mur	09.00.03.020.2 + 09.00.03.220.6 + 09.00.03.370.3	10
CABLE CU EXTRA FLEX 5X1,5MM2	04.08.61.735.4	Prise rect. HAN Q7/0 + contact femelle + Straight Metal Housing	09.21.07.027.9 + 09.21.07.457.9 + 09.21.07.220.8	8
Triphasé	04.08.61.739.0	Prise 32A Mur RG	09.00.10.334.4	4
MCA24	04.21.48.324.9	SUB – D 25 male	09.21.20.710.8 (25 pin male connector) 09.21.23.144.1 (plastic hood)	2
MCA8	04.21.48.308.9	SUB – D 9 male	09.21.20.702.8 (9 pin male connector) 09.21.23.140.5 (plastic hood)	4
NG04	04.21.52.180.6	BURNDY ROUND MULTI-PIN CONNECTORS	09.31.05.200.5	2
Samtec EQCD (ucoax)	No S.C.E.M	Integrated with cable	No S.C.E.M	3
Samtec paire differentielle (ucoax)	No S.C.E.M	Integrated with cable	No S.C.E.M	3
CBH50 (High Voltage)	04.31.51.555.2	Fiche Cable sertie Teflon - Femelle SHV 5kV	09.41.25.108.3	12
Unipolar cable	04.08.61.994.7	Cosses	04.76.21.114.0	4
Cable for cooling (water)	38.20.10	Voir avec CV pour diamètre en fonction de la longueur (éviter trop de perte de charge)	Besoin aux bornes du convertisseur de 3l/min et 3 bars (à H4 cable 16*27)	2
ND26	04.21.52.020.1	Capot+ Connecteur SubD femelle+ Connecteur SubD Male	09.21.23.015.8 + 09.21.20.709.1 + 09.21.20.710.8	10
CKB50 (triax cables) internal conductor	04.61.11.254.1	Specific connectors that will be bought by BE/BI team + connectors for the insulated patch panel		10
Serial Link (RS485)	04.21.48.308.9	Connecteurs femelle	09.21.21.010.2 (Connector) 09.21.21.310.3 (Contact F)	4
USB	No S.C.E.M	Integrated with cable	No S.C.E.M	5
Total				212

Facility Overview

Patch Panel «IN»



Patch Panel «OUT»



Facility Design Targets

- @ Contrary to other facilities:
 - @ Setup needs to be radtol
 - @ Large distance: ≈ 30 m of cables. Designer needs to integrate in their design the possibility to measure short signal (e.g. short transient “few ns”)
- @ **But ...**
- @ Numerous **representative radiation fields**
 - @ Mixed-Particle-Energy
 - @ Direct beam exposure
- @ **Large range of fluxes and dose ranges**
(covering accelerator, but also other applications)

Facility Design Targets

- ⊙ Possibility for **large volumes**/high number of components or full systems
- ⊙ **Easy usage**
 - ⊙ Dedicated preparation area
 - ⊙ Cables pre-installed + patch panel
 - ⊙ Conveyer systems
- ⊙ Detailed, on-line and **high-accuracy monitoring** (CERN RadMon system)



Conclusions

- ⊙ **High-energies are of concern!**
(especially for destructive failures)
- ⊙ Testing **complex systems or many components** can be important/useful
- ⊙ **Representative environments** are an efficient approach also for LHC experiments
- ⊙ A **new test facility** will soon be available at **CERN (mid-2014)**